

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TIEN-FU HUANG	11/09/2021
LI-SEN CHEN	11/09/2021
YI-FU CHIU	11/09/2021
I-TING HSIEH	11/09/2021
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17526194
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DATE SIGNED:	11/15/2021
Total Attachments: 2	
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ASSIGNMENT**美國專利轉讓**

For the subject matter which is claimed and for which a patent is sought on the invention entitled:
專利申請權利要求的發明名稱如下:

**CONDUCTIVE ASSEMBLY, TERMINAL ASSEMBLY STRUCTURE OF
CONNECTOR AND CONNECTOR STRUCTURE**

WHEREAS, (we), **HUANG, TIEN-FU; CHEN, LI-SEN; CHIU, YI-FU; HSIEH, I-TING**, whose post office

address(es) appear(s) below, hereinafter referred to as ASSIGNOR.
作為下述其郵遞地址的發明者, 在此稱轉讓人。

WHEREAS, **INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE**
whose post office address is **195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu, 310401, Taiwan, R.O.C.**, hereinafter referred
to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial
possessions. 在此稱讓受人, 取得此發明在美國與其管轄境內之所有權利。

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these
presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application
throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part,
and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any
International Convention.

根據所收到的相關價值, 轉讓人謹此將本發明轉讓於讓受人, 此轉讓包括本發明以及本發明案之所有在美國的相關權利, 包括任
何專利有效期內的分案, 續案, 重新核發案, 並包括在國際公約所保障的優先權。

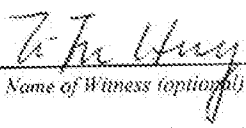
ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which
would conflict with this Assignment.

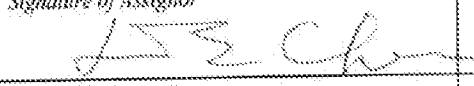
轉讓人將不會簽署任何與此轉讓書相悖逆的再轉讓, 販售, 或合同協議。

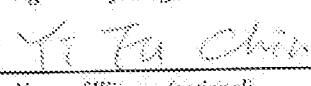
ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and
maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional
documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR
also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request
documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further
assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance,
litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under
this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

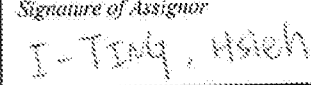
轉讓人將無條件協助簽署任何法律上所需要與本發明相關的文件, 包括提交申請, 核駁答辯, 年費, 以及任何證明讓受人擁有本發
明之文件。在讓受人的要求下, 轉讓人也將無條件協助讓受人, 提供讓受人轉讓人所持有的發明文件資料, 並提供讓受人或是讓
受人的法定繼承人, 在法律上所要求的核駁答辯, 侵權訴訟相關協助。

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent
referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and
behoof, and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such Letters
Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.
轉讓人在此要求美國專利商標局在核發本發明專利時, 根據以上所呈訴讓受人在本發明以及本發明案之所有在美國的相關權利,
核發於讓受人。

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Signature of Witness (optional)	Signature of Witness (Optional)

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Signature of Witness (optional)	Signature of Witness (Optional)

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Signature of Witness (optional)	Signature of Witness (Optional)

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Signature of Assignor 	Date of Signature 11/09/2021
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)